CORSAIR



| Embargo Date | 18-Dec-18 |
|--------------------------|--|
| First Customer Ship Date | 7-Dec-18 |
| Product Full Name | CORSAIR TM30 Performance Thermal Paste |
| Etail Product Title | CORSAIR TM30 |
| Pre-Order Option | No |
| Product Imagery | Image Assets |
| | |

Overview

25 Word Product Description

CORSAIR TM30 thermal paste helps you push your PC to its limit, with a low-viscosity premium zinc oxide thermal material that's easy to apply.

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50 Word Product Description

CORSAIR TM30 thermal paste helps you push your PC to its limit, with a low-viscosity premium zinc oxide thermal material that's easy to apply. TM30's ultra-low thermal impedance ensures high-efficiency heat transfer between your hardware and cooler, lowering temperatures and allowing for higher clock speeds.

Overview

100 Word Product Description

CORSAIR TM30 thermal paste helps you push your PC to its limit, with a low-viscosity zinc oxide thermal material that's easy to apply. TM30's ultra-low thermal impedance ensures high-efficiency heat transfer between your hardware and cooler, lowering temperatures and allowing for higher clock speeds. Each syringe contains enough TM30 for multiple standard CPU applications, and once installed, TM30 lasts for years with no drying, cracking or thermal degradation. Whether you use liquid or air cooling, CORSAIR TM30 thermal paste is ready to keep your PC cool under pressure and handle the hottest CPUs and GPUs with ease.



Features and Benefits

| ium Zinc Oxide based thermal compound for optimal thermal performance. I new, or replace existing, thermal compound on your CPU and GPU to improve heat transfer and lower temperatures. Iow thermal impedance lowers CPU temperatures vs common thermal paste. AIR TM30's low-viscosity allows it to easily fill microscopic abrasions and channels for peak thermal transfer. installed, CORSAIR TM30's high-stability liquid compound lasts for years with no drying, cracking or change in consistency. conductive, non-toxic and contains zero volatile compounds. Isiast CPU Thermal Compound: Premium Zinc Oxide based thermal compound for optimal thermal performance. your CPU and GPU: Install new, or replace existing thermal compound on your CPU and GPU to improve heat transfer and lower temperatures. |
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| vour CPU and GPU: Install new. or replace existing thermal compound on your CPU and GPU to improve heat transfer and lower temperatures. |
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| oved CPU Cooling: Ultra-low thermal impedance lowers CPU temperatures vs common thermal paste. |
| the Gap: CORSAIR TM30's low-viscosity allows it to easily fill microscopic abrasions and channels in your CPU and cooler, for maximum thermal transfe |
| Life: CORSAIR TM30's high-stability liquid compound lasts for years with no drying, cracking or change in consistency. |
| For You And Your PC: Non-conductive, non-toxic and contains zero volatile compounds. |
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Thermal Paste, TIM, Thermal Material, Thermal Interface Material, Heat Transfer material, Heat Transfer, Thermal, Compound, Thermal Goo, Cooling Paste, Cooling Material, Thermal Compound Paste, Thermal Compound Paste, Thermal Compound Paste, Thermal Gue

| Tech Specs | | | | | |
|--------------------------------|------------|----------------------|----------------------------|-----------|----------------------|
| Туре | Net Weight | Thermal Conductivity | Thermal Impedance | Viscosity | Specific Gravity |
| TM30 Performance Thermal Paste | Зg | 3.8 W/mK | 0.01°C -in ² /W | 2300K cPs | 2.5g/cm ³ |

Box Contents

• 1x CORSAIR TM30 Performance Thermal Paste

| Shipping Info | ormation | | | | | | | | | | |
|--|---------------|--------------|---|-------------------------|------------------------|--|--------------------|----------------------------|--|------------------------------------|------------------|
| Model | Part Number | UPC Code | Retail Box Dimensions (mm) | Shipping Weight (kg) | Product Weight (kg) | Product Dimensions (mm) | Pallet Quantity | Master Pack Quantity | Master Carton Dimensions (mm) | Master Carton Weight (kg) | HTS |
| CORSAIR TM30 Performance Thermal Paste | CT-9010001-WW | 843591074506 | 100mm x 160mm x 18mm / 3.94" x 6.30" x 0.71" | lbs | 0.006kg / 0.01 Ibs | 115mm x 25mm x 13mm / 4.53" x 0.98" x 0.51" | 4200 | 20 | 175mm x 180mm x 150mm / 6.89" x 7.09" x 5.91" | 0.52kg / 1.15 lbs | 3910.00.000 0 |